

**IN THE SPECIFICATION:**

In the title:

Method of Assembling a Silicon Carbide High Temperature Anemometer and ~~Method of Assembling the Same~~

Immediately after the title, please insert:

This is a divisional of application Ser. No. 10/233,182, which was filed on 8/29/2003 and is now issued as U.S. Patent No. \_\_\_\_\_.